



Product Specification

SPECIFICATION FOR APPROVAL

() P	relimina	ary Sp	ecification
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(
) Final Specification

Title	47.0" WUXGA TFT LCD

BUYER	General
MODEL	

SUPPLIER	LG.Display Co., Ltd.
*MODEL	LC470EUH
SUFFIX	SCA1(RoHS Verified)

^{*}When you obtain standard approval, please use the above model name without suffix

APPROVED BY	SIGNATURE DATE
/	
1	
Please return 1 copy for your	confirmation with
your signature and c	omments.

APPROVED BY	SIGNATURE DATE
P.Y. Kim /Team Leader	
REVIEWED BY Y.J. Heo / Project Leader	
PREPARED BY	
K.S. Kim / Engineer	
TV Product Developme LG Display Co., I	

Ver. 1.2 0 /34



Product Specification

CONTENTS

Number	ITEM	Page
	COVER	0
	CONTENTS	1
	RECORD OF REVISIONS	2
1	GENERAL DESCRIPTION	3
2	ABSOLUTE MAXIMUM RATINGS	4
3	ELECTRICAL SPECIFICATIONS	5
3-1	ELECTRICAL CHARACTERISTICS	5
3-2	INTERFACE CONNECTIONS	8
3-3	SIGNAL TIMING SPECIFICATIONS	11
3-4	DATA MAPPING AND TIMING	14
3-5	PANEL PIXEL STRUCTURE	15
3-6	POWER SEQUENCE	16
4	OPTICAL SPECIFICATIONS	17
5	MECHANICAL CHARACTERISTICS	21
6	RELIABILITY	24
7	INTERNATIONAL STANDARDS	25
7-1	SAFETY	25
7-2	Environment	25
8	PACKING	26
8-1	DESIGNATION OF LOT MARK	26
8-2	PACKING FORM	26
9	PRECAUTIONS	27
9-1	MOUNTING PRECAUTIONS	27
9-2	OPERATING PRECAUTIONS	27
9-3	ELECTROSTATIC DISCHARGE CONTROL	28
9-4	PRECAUTIONS FOR STRONG LIGHT EXPOSURE	28
9-5	STORAGE	28
9-6	HANDLING PRECAUTIONS FOR PROTECTION FILM	28

Ver. 1.2 1/34



Product Specification

RECORD OF REVISIONS

Revision No.		Page	Description					
0.0	Aug, 20, 2009	-	Preliminary Specification(First Draft)					
1.2	Feb. 10. 2010	7	Final Specification					
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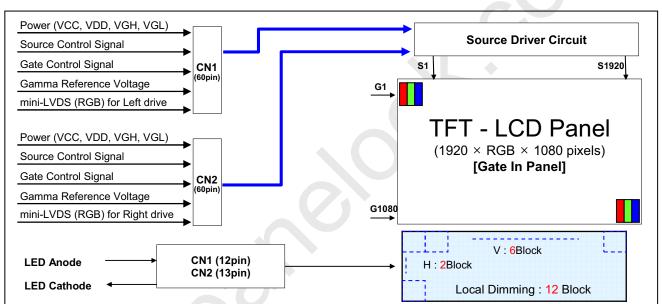
Ver. 1.2 2 /34

Product Specification

1. General Description

The LC470EUH is a Color Active Matrix Liquid Crystal Display with an integral Light Emitting Diode (LED) backlight system. The matrix employs a-Si Thin Film Transistor as the active element. It is a transmissive type display operating in the normally black mode. It has a 46.96 inch diagonally measured active display area with WUXGA resolution (1080 vertical by 1920 horizontal pixel array). Each pixel is divided into Red, Green and Blue sub-pixels or dots which are arranged in vertical stripes. Gray scale or the luminance of the sub-pixel color is determined with a 8-bit gray scale signal for each dot. Therefore, it can present a palette of more than 16.7M(true) colors.

It is intended to support LCD TV, PCTV where high brightness, super wide viewing angle, high color gamut, high color depth and fast response time are important.



General Features

<u>Jonorai i Jataroo</u>	
Active Screen Size	46.96 inch (1192.87mm) diagonal
Outline Dimension	1083.6(H) X 628.8(V) X 21.0(D) /10.8(B) mm (Typ.)
Pixel Pitch	0.5415 mm x 0.5415 mm
Pixel Format	1920 horiz. by 1080 vert. Pixels, RGB stripe arrangement
Color Depth	8-bit, 16.7 M colors (※ 1.06B colors @ 10 bit (D) System Output)
Drive IC Data Interface	Source D-IC : 8-bit mini-LVDS, gamma reference voltage, and control signals Gate D-IC : Gate In Panel
Luminance, White	450 cd/m ² (Center 1point ,Typ.)
Viewing Angle (CR>10)	Viewing angle free (R/L 178 (Min.), U/D 178 (Min.))
Power Consumption	Total 110.5W (Typ.) (Logic=8.5W with T-CON, LED Backlight =102W@ with Driver)
Weight	14.0Kg (Typ)
Display Mode	Transmissive mode, Normally black
Surface Treatment	Hard coating(3H), Anti-glare treatment of the front polarizer (Haze 10%)

Ver. 1.2 3 /34



Product Specification

2. Absolute Maximum Ratings

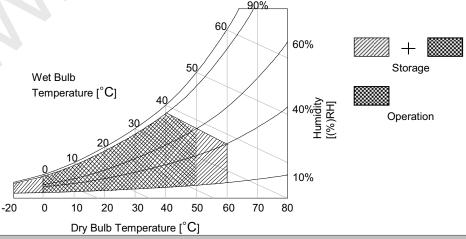
The following items are maximum values which, if exceeded, may cause faulty operation or damage to the LCD module.

Table 1. ABSOLUTE MAXIMUM RATINGS

D	Or mark at	Va	lue	1124	Note
Parameter	Symbol			Max Unit	
Logic Power Voltage	VCC	-0.5	+4.0	VDC	
Gate High Voltage	VGH	+18.0	+30.0	VDC	
Gate Low Voltage	VGL	-8.0	-4.0	VDC	
Source D-IC Analog Voltage	VDD	-0.3	+18.0	VDC	1
Gamma Ref. Voltage (Upper)	VGMH	½VDD-0.5	VDD+0.5	VDC	
Gamma Ref. Voltage (Low)	VGML	-0.3	½ VDD+0.5	VDC	
LED Input Voltage	VF	-	+180.0	VDC	
Panel Front Temperature	Tsur	-	+68	°C	4
Operating Temperature	Тор	0	+50	°C	
Storage Temperature	Тѕт	-20	+60	°C	
Operating Ambient Humidity	Нор	10	90	%RH	2,3
Storage Humidity	Нѕт	10	90	%RH	1

Note: 1. Ambient temperature condition (Ta = 25 ± 2 °C)

- 2. Temperature and relative humidity range are shown in the figure below. Wet bulb temperature should be Max 39 °C and no condensation of water.
- 3. Gravity mura can be guaranteed below 40 ℃ condition.
- 4. The maximum operating temperature is based on the test condition that the surface temperature of display area is less than or equal to 68 °C with LCD module alone in a temperature controlled chamber. Thermal management should be considered in final product design to prevent the surface temperature of display area from being over 68 °C. The range of operating temperature may degrade in case of improper thermal management in final product design.



Ver. 1.2 4 /34

Product Specification

3. Electrical Specifications

3-1. Electrical Characteristics

It requires several power inputs. The VCC is the basic power of LCD Driving power sequence, Which is used to logic power voltage of Source D-IC and GIP.

Table 2. ELECTRICAL CHARACTERISTICS

Parameter	Symbol	Condition	MIN	TYP	MAX	Unit	Note
Logic Power Voltage	VCC	-	3.0	3.3	3.6	VDC	
Logic High Level Input Voltage	VIH		2.7		VCC	VDC	
Logic Low Level Input Voltage	VIL		0		0.6	VDC	
Source D-IC Analog Voltage	VDD	-	15.3	15.5	15.7	VDC	
Half Source D-IC Analog Voltage	H_VDD	-	7.45	7.68	7.82	VDC	7
O D-f \/-#	V_{GMH}	(GMA1 ~ GMA9)	½*VDD		VDD-0.2		
Gamma Reference Voltage	V_{GML}	(GMA10 ~ GMA18)	3.0 3.3 3.6 2.7 VCC 0 0.6 15.3 15.5 15.7 7.45 7.68 7.82 A9) ½*VDD VDD-0.: A18) 0.2 ½*VDD 6.47 6.77 7.07 6.47 6.77 7.07 3.6V 312 (VCC-1.: - VID / 0.8	½*VDD			
0		Normal	6.47	6.77	7.07	V	
Common Voltage	Vcom	Reverse			V		
Mini-LVDS Clock frequency	CLK	3.0V≤VCC ≤3.6V			312	MHz	
mini-LVDS input Voltage (Center)	VIB		0.7 + (VID/2)		(VCC-1.2) - VID / 2	V	
mini-LVDS input Voltage Distortion (Center)	ΔVIB	Mini-LVDS Clock			0.8	V	
mini-LVDS differential Voltage range	VID	and Data	150		800	mV	5
mini-LVDS differential Voltage range Dip	ΔVID		25		800	mV	
0 (11: 1) / 1:) (OLI	@ 25 ℃	27.7	28	28.3	VDC	
Gate High Voltage	VGH	@ 0℃	28.7	29	29.3	VDC	
Gate Low Voltage	VGL		-5.2	-5.0	-4.8	VDC	
GIP Bi-Scan Voltage	VGI_P VGI_N	-	VGL	-	VGH	VDC	
GIP Refresh Voltage	VGH even/odd	-	VGL	-	VGH	V	
GIP Start Pulse Voltage	VST	-	VGL	-	VGH	V	
GIP Operating Clock	GCLK	-	VGL	-	VGH	V	
Total Power Current	ILCD	-		800	1040	mA	2
Total Power Consumption	PLcd	-		8.53	11.09	Watt	2

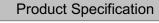
Note: 1. The specified current and power consumption are under the V_{LCD}=12V., $25 \pm 2^{\circ}$ C, f_V =120Hz condition whereas mosaic pattern(8 x 6) is displayed and f_V is the frame frequency.

- 2. The above spec is based on the basic model.
- 3. All of the typical gate voltage should be controlled within 1% voltage level
- 4. Ripple voltage level is recommended under 10%
- 5. In case of mini-LVDS signal spec, refer to Fig 2 for the more detail.
- 6. Logic Level Input Signal: SOE, POL, GSP, H CONV, OPT N
- 7. HVDD Voltage level is half of VDD and it should be between Gamma9 and Gamma10.

Ver. 1.2 5 /34

Global LCD Panel Exchange Center





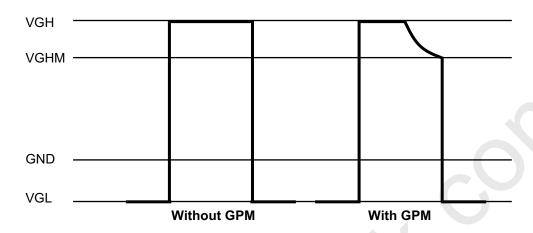


FIG. 1 Gate Output Wave form without GPM and with GPM

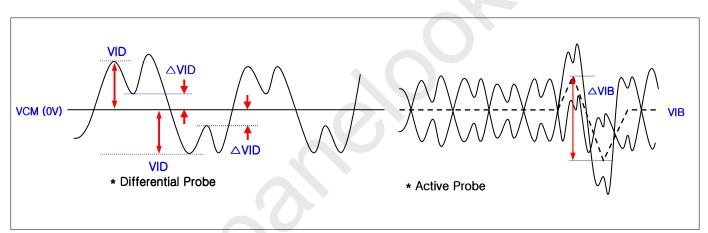


FIG. 2 Description of VID, ∆VIB, ∆VID

* Source PCB

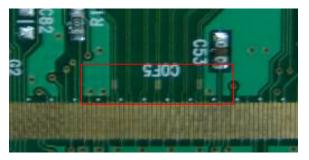


FIG. 3 Measure point

Ver. 1.2 6 /34

Product Specification

Table 3. ELECTRICAL CHARACTERISTICS (Continue)

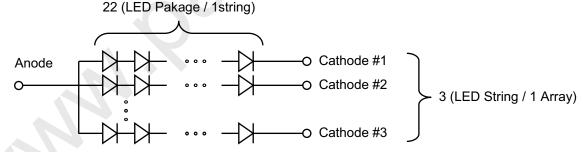
Parameter		Symbol	Values			Unit	Note
		- Oyillboi	Min Typ		Max	Oille	Hote
Backlight Asseml	bly :	•					
Forward Current	Anode	I _{F (anode)}		165		mAdc	±5%
(one array)	Cathode	I _{F (cathode)}	52.25	55	57.75	mAdc	2, 3
Forward Voltage		V _F	127.6	136.4	145.2	Vdc	4
Forward Voltage V	ariation	$\triangle V_{F}$			1.7	Vdc	5
Power Consumption	on	P _{BL}	80.0	90.0	100.6	W	6
Burst Dimming Dut	ty	On duty	1		100	%	
Burst Dimming Frequency		1/T	95		182	Hz	8
LED Array : (APP	ENDIX-V)						
Life Time			30,000	50,000		Hrs	7

Notes : The design of the LED driver must have specifications for the LED array in LCD Assembly.

The electrical characteristics of LED driver are based on Constant Current driving type.

The performance of the LED in LCM, for example life time or brightness, is extremely influenced by the characteristics of the LED Driver. So, all the parameters of an LED driver should be carefully designed. When you design or order the LED driver, please make sure unwanted lighting caused by the mismatch of the LED and the driver (no lighting, flicker, etc) has never been occurred. When you confirm it, the LCD-Assembly should be operated in the same condition as installed in your instrument.

- 1. Electrical characteristics are based on LED Array specification.
- 2. Specified values are defined for a Backlight Assembly. (IBL: 4 LED array, 165mA/LED array)
- 3. Each LED array has one anode terminal and three cathode terminals. The forward current(I_F) of the anode terminal is 165mA and it supplies 55mA into three strings, respectively



- 4. The forward voltage(V_F) of LED array depends on ambient temperature (Appendix-III)
- 5. ΔV_F means Max V_F -Min V_F in one Backlight. So V_F variation in a Backlight isn't over Max. 1.7V
- 6. Maximum level of power consumption is measured at initial turn on. Typical level of power consumption is measured after 1hrs aging at $25 \pm 2^{\circ}$ C.
- 7. The life time(MTTF) is determined as the time at which brightness of the LED is 50% compared to that of initial value at the typical LED current on condition of continuous operating at $25 \pm 2^{\circ}$ C, based on duty 100%.
- 8. The reference method of burst dimming duty ratio. It is recommended to use synchronous V-sync frequency to prevent waterfall (Vsync x 1 =Burst Frequency)

Though PWM frequency is over 182Hz (max252Hz), function of backlight is not affected.

Product Specification

3-2. Interface Connections

This LCD module employs two kinds of interface connection, two 60-pin FFC connector are used for the module electronics and 12-pin,13-pin connectors are used for the integral backlight system.

3-2-1. LCD Module

-LCD Connector (CN1): TF06L-60S-0.5SH (Manufactured by HRS) or Equivalent

Table 4-1. MODULE CONNECTOR(CN1) PIN CONFIGURATION

			1	I					
No	Symbol	Description	No	Symbol	Description				
1	GND	Ground	31	LLV3 -	Left Mini LVDS Receiver Signal(3-)				
2	LTD_OUT	LTD OUTPUT	32	LLV3 +	Left Mini LVDS Receiver Signal(3+)				
3	GCLK1	GIP GATE Clock 1	33	LCLK -	Left Mini LVDS Receiver Clock Signal(-)				
4	GCLK2	GIP GATE Clock 2	34	LCLK +	Left Mini LVDS Receiver Clock Signal(+)				
5	GCLK3	GIP GATE Clock 3	35	LLV2 -	Left Mini LVDS Receiver Signal(2-)				
6	GCLK4	GIP GATE Clock 4	36	LLV2 +	Left Mini LVDS Receiver Signal(2+)				
7	GCLK5	GIP GATE Clock 5	37	LLV1 -	Left Mini LVDS Receiver Signal(1-)				
8	GCLK6	GIP GATE Clock 6	38	LLV1+	Left Mini LVDS Receiver Signal(1+)				
9	VGI_N	GIP Bi-Scan (Normal =VGL Rotate = VGH)	39	LLV0 -	Left Mini LVDS Receiver Signal(0-)				
10	VGI_P	GIP Bi-Scan (Normal =VGH Rotate = VGL)	40	LLV0 +	Left Mini LVDS Receiver Signal(0+)				
11	VGH_ODD	GIP Panel VDD for Odd GATE TFT	41	GND	Ground				
12	VGH_EVEN	GIP Panel VDD for Even GATE TFT	42	SOE	Source Output Enable SIGNAL				
13	VGL	GATE Low Voltage	43	POL	Polarity Control Signal				
14	VST	VERTICAL START PULSE	44	GSP	GATE Start Pulse				
15	GND	Ground	45	H_CONV	"H" H 2dot Inversion/ "L" H 1dot Inversion				
16	VCOM_L_FB	VCOM Left Feed-Back Output	46	OPT_N	"H" Normal Display / "L" Rotation Display				
17	VCOM_L	VCOM Left Input	47	GND	Ground				
18	GND	Ground	48	GMA 18	GAMMA VOLTAGE 18 (Output From LCD)				
19	VDD	Driver Power Supply Voltage	49	GMA 16	GAMMA VOLTAGE 16				
20	VDD	Driver Power Supply Voltage	50	GMA 15	GAMMA VOLTAGE 15				
21	H_VDD	Half Driver Power Supply Voltage	51	GMA 14	GAMMA VOLTAGE 14				
22	H_VDD	Half Driver Power Supply Voltage	52	GMA 12	GAMMA VOLTAGE 12				
23	GND	Ground	53	GMA 10	GAMMA VOLTAGE 10 (Output From LCD)				
24	VCC	Logic Power Supply Voltage	54	GMA 9	GAMMA VOLTAGE 9 (Output From LCD)				
25	VCC	Logic Power Supply Voltage	55	GMA 7	GAMMA VOLTAGE 7				
26	GND	Ground	56	GMA 5	GAMMA VOLTAGE 5				
27	LLV5 -	Left Mini LVDS Receiver Signal(5-)	57	GMA 4	GAMMA VOLTAGE 4				
28	LLV5 +	Left Mini LVDS Receiver Signal(5+)	58	GMA 3	GAMMA VOLTAGE 3				
29	LLV4 -	Left Mini LVDS Receiver Signal(4-)	59	GMA 1	GAMMA VOLTAGE 1 (Output From LCD)				
30	LLV4 +	Left Mini LVDS Receiver Signal(4+)	60	OPEN	Open				

Note: 1. Please refer to application note for details.

(GIP & Half VDD & Gamma Voltage & H_CONV setting)

2. These 'input signal' (OPT_N,H_CONV) should be connected

Ver. 1.2 8 /34



Product Specification

-LCD Connector (CN2): TF06L-60S-0.5SH (Manufactured by HRS) or Equivalent

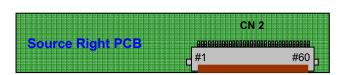
Table 4-2. MODULE CONNECTOR(CN2) PIN CONFIGURATION

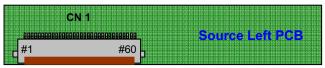
No	Symbol	Description		No	Symbol	Description
1	OPEN	Open	T	31	RLV1 -	Right Mini LVDS Receiver Signal(1-)
2	GMA 1	GAMMA VOLTAGE 1 (Output From LCD)		32	RLV1 +	Right Mini LVDS Receiver Signal(1+)
3	GMA 3	GAMMA VOLTAGE 3		33	RLV0 -	Right Mini LVDS Receiver Signal(0-)
4	GMA 4	GAMMA VOLTAGE 4	T	34	RLV0 +	Right Mini LVDS Receiver Signal(0+)
5	GMA 5	GAMMA VOLTAGE 5		35	GND	Ground
6	GMA 7	GAMMA VOLTAGE 7		36	VCC	Logic Power Supply Voltage
7	GMA 9	GAMMA VOLTAGE 9 (Output From LCD)		37	VCC	Logic Power Supply Voltage
8	GMA 10	GAMMA VOLTAGE 10 (Output From LCD)		38	GND	Ground
9	GMA 12	GAMMA VOLTAGE 12		39	H_VDD	Half Driver Power Supply Voltage
10	GMA 14	GAMMA VOLTAGE 14		40	H_VDD	Half Driver Power Supply Voltage
11	GMA 15	GAMMA VOLTAGE 15		41	VDD	Driver Power Supply Voltage
12	GMA 16	GAMMA VOLTAGE 16		42	VDD	Driver Power Supply Voltage
13	GMA 18	GAMMA VOLTAGE 18 (Output From LCD)		43	GND	Ground
14	GND	Ground		44	VCOM_R	VCOM Right Input
15	OPT_N	"H" Normal Display / "L" Rotation Display		45	VCOM_R_FB	VCOM Right Feed-Back Output
16	H_CONV	"H" H 2dot Inversion/ "L" H 1dot Inversion		46	GND	Ground
17	GSP	GATE Start Pulse		47	VST	VERTICAL START PULSE
18	POL	Polarity Control Signal		48	VGL	GATE Low Voltage
19	SOE	Source Output Enable SIGNAL		49	VGH_EVEN	GIP Panel VDD for Even GATE TFT
20	GND	Ground		50	VGH_ODD	GIP Panel VDD for Odd GATE TFT
21	RLV5 -	Right Mini LVDS Receiver Signal(5-)		51	VGI_P	GIP Bi-Scan (Normal =VGH Rotate = VGL)
22	RLV5 +	Right Mini LVDS Receiver Signal(5+)		52	VGI_N	GIP Bi-Scan (Normal =VGL Rotate = VGH)
23	RLV4 -	Right Mini LVDS Receiver Signal(4-)		53	GCLK6	GIP GATE Clock 6
24	RLV4 +	Right Mini LVDS Receiver Signal(4+)	T	54	GCLK5	GIP GATE Clock 5
25	RLV3 -	Right Mini LVDS Receiver Signal(3-)		55	GCLK4	GIP GATE Clock 4
26	RLV3 +	Right Mini LVDS Receiver Signal(3+)		56	GCLK3	GIP GATE Clock 3
27	LCLK -	Right Mini LVDS Receiver Clock Signal(-)		57	GCLK2	GIP GATE Clock 2
28	LCLK +	Right Mini LVDS Receiver Clock Signal(+)	1	58	GCLK1	GIP GATE Clock 1
29	RLV2 -	Right Mini LVDS Receiver Signal(2-)	1	59	LTD_OUT	LTD OUTPUT
30	RLV2 +	Right Mini LVDS Receiver Signal(2+)		60	GND	Ground

Note: 1. Please refer to application note for details

(GIP & Half VDD & Gamma Voltage & H_CONV setting)

2. These 'input signal' (OPT_N,H_CONV) should be connected





Ver. 1.2 9 /34

Product Specification

3-2-2. Backlight Module

[CN1]

1) LED Array assy Connector (Plug)

: 20010HS-12 (manufactured by Yeonho)or equivalent

2) Mating Connector (Receptacle)

: 20010WR-12B1 (manufactured by Yeonho)or equivalent

[CN2]

1) LED Array assy Connector (Plug)

: 20010HS-13 (manufactured by Yeonho)or equivalent

2) Mating Connector (Receptacle)

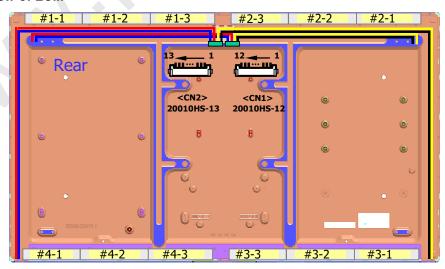
: 20010WR-13B1 (manufactured by Yeonho)or equivalent

Table 5. BACKLIGHT CONNECTOR PIN CONFIGURATION(CN1,CN2)

No	Symbol	Description	Note
1	#1 Anode	LED Input Current	
2	N.C	Open	
3	#1-1 Cathode	LED Output Current	
4	#1-2 Cathode	LED Output Current	
5	#1-3 Cathode	LED Output Current	
6	N.C	Open	
7	N.C	Open	
8	#2-3Cathode	LED Output Current	
9	#2-2 Cathode	LED Output Current	
10	#2-1 Cathode	LED Output Current	
11	N.C	Open	
12	#2 Anode	LED Input Current	

No	Symbol	Description	Note
1	#3 Anode	LED Input Current	
2	N.C	Open	
3	#3-1 Cathode	LED Output Current	
4	#3-2 Cathode	LED Output Current	
5	#3-3 Cathode	LED Output Current	
6	N.C	Open	
7	N.C	Open	
8	N.C	Open	
9	#4-3Cathode	LED Output Current	
10	#4-2 Cathode	LED Output Current	
11	#4-1 Cathode	LED Output Current	
12	N.C	Open	
13	#4 Anode	LED Input Current	

◆ Rear view of LCM



Product Specification

3-3. Signal Timing Specifications

Table 6. Timing Requirements

ble 6. Tilling Requiremen							
Parameter	Symbol	Condition	Min	Тур	Max	Unit	Note
Mini Clock pulse period	T1		3.2	3.4		ns	
Mini Clock pulse low period	T2		1.6	-	-	ns	
Mini Clock pulse high period	Т3		1.6	-	-	ns	1
Mini Data setup time	T6		0.6	-		ns	
Mini Data hold time	T 7		0.6	-		ns	
Reset low to SOE rising time	Т8		0	-	-	ns	
SOE to Reset input time	T9		200	-	-	ns	
Receiver off to SOE timing	T10		10	-	-	CLK cycle	
POL signal to SOE setup time	T11		-5	-	-	ns	
POL signal to SOE hold time	T12		6	-	-	ns	
Reset High Period	T13		3			CLK cycle	
SOE signal GSP setup time	T14		100			ns	
SOE signal GSP Hold time	T15		100			ns	
SOE signal Pulse Width	T16		200			ns	

Note: 1. Mini-LVDS timing measure conditions

: 268MHz < Clock Frequency < 312MHz , 150mV < VID < 800mV @ 3.0<VCC<3.3

2. Setup time and hold time should be satisfied at the same time

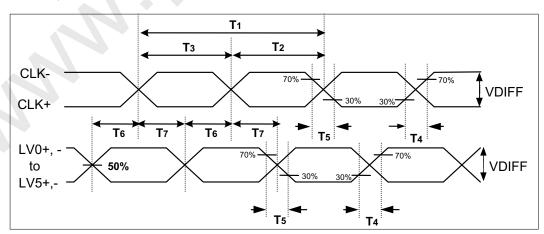


FIG 4. Source D-IC Input Data Latch Timing Waveform



Product Specification

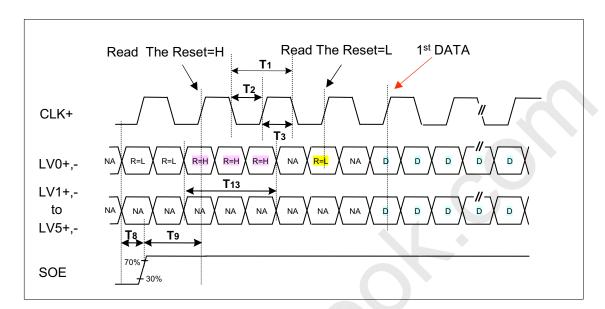


FIG 5-1. Input Data Timing for 1st Source D-IC Chip

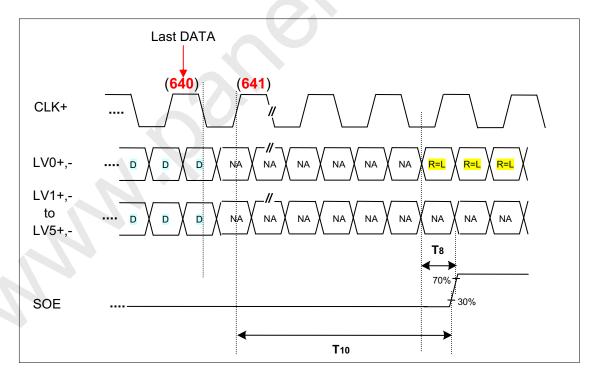


FIG 5-2. Last Data Latch to SOE Timing



Product Specification

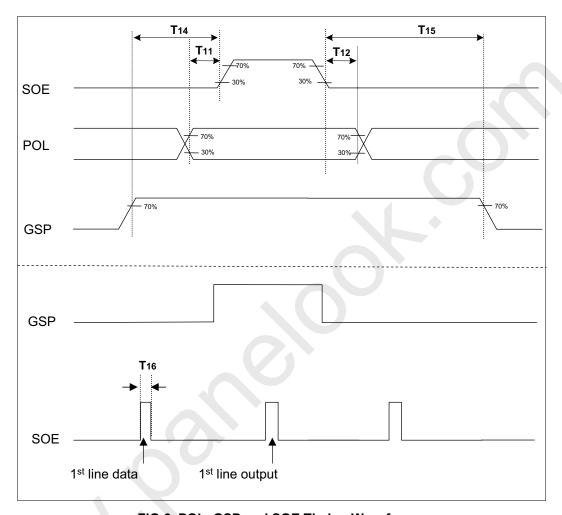


FIG 6. POL, GSP and SOE Timing Waveform

Ver. 1.2 13 /34

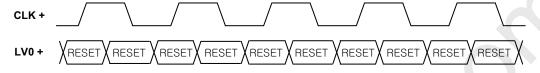


Product Specification

3-4. Data Mapping and Timing

Display data and control signal (RESET) are input to LV0 to LV5.

3-4-1. Control signal input mode



3-4-2. Display data input mode

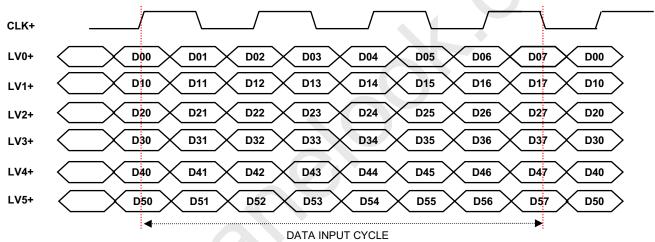


Fig. 7 Mini-LVDS Data

Note: 1. For data mapping, please refer to panel pixel structure Fig.8



Product Specification

3-5. Panel Pixel Structure

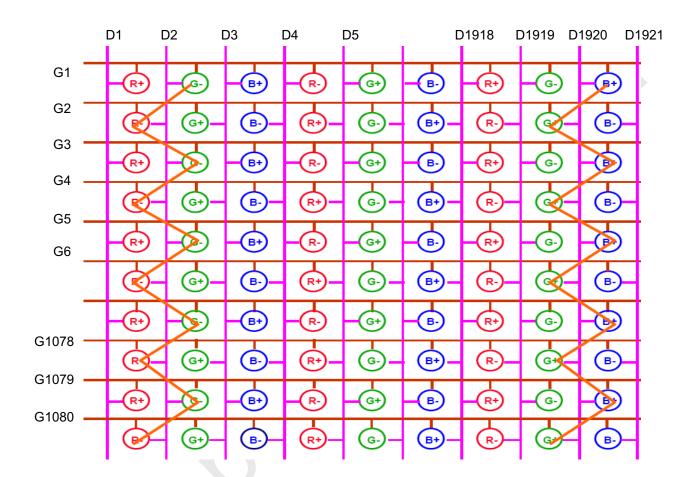


FIG. 8 Panel Pixel Structure

T7



T2

100%

70%

50%

٥v

0V-

3-6. Power Sequence

3-6-1. LCD Driving circuit

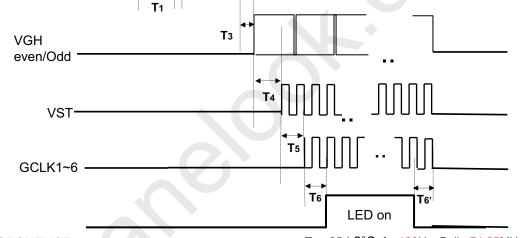
Global LCD Panel Exchange Center

Power Supply For LCD VCC

Power Supply For LCD VDD, HVDD, VGH, Gamma Ref. Voltage

Power Supply For LCD **VGL**

GIP Signal For LCD



VGH

90%

Power For LED

Table 7. POWER SEQUENCE

Ta= $25\pm2^{\circ}$ C, fv=120Hz, Dclk=74.25MHz

TUDIC 7. 1 OWLING	, <u></u> , _,				
Davamatar		11	No.45 -		
Parameter	Min	Тур	Max	Unit	Notes
T1	0.5		-	ms	
T2	0.5		-	ms	
Т3	0		-	ms	
T4	10		-	ms	2
T 5	0		-	ms	
T6 / T6'	20		-	ms	
Т7	2		-	sec	

Note: 1. Power sequence for Source D-IC must follow the Case1 & 2. Please refer to Appendix V for more details.

- 2. VGH Odd signal should be started "High" status and VGH even & odd can not be "High at the same time.
- 3. Power Off Sequence order is reverse of Power On Condition including Source D-IC.
- 4. GCLK On/Off Sequence

Normal: GCLK4 \rightarrow GCLK5 \rightarrow GCLK6 \rightarrow GCLK1 \rightarrow GCLK2 \rightarrow GCLK3. Reverse : GCLK3 \rightarrow GCLK2 \rightarrow GCLK1 \rightarrow GCLK6 \rightarrow GCLK5 \rightarrow GCLK4.

5. VDD_odd/even transition time should be within V_blank



Product Specification

4. Optical Specification

Optical characteristics are determined after the unit has been 'ON' and stable in a dark environment at $25\pm2^{\circ}$ C. The values are specified at an approximate distance 50cm from the LCD surface at a viewing angle of Φ and θ equal to 0 °.

It is presented additional information concerning the measurement equipment and method in FIG. 9.

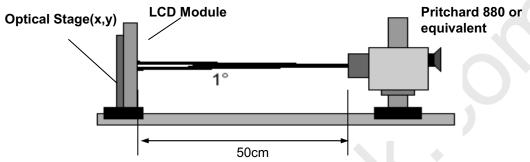


FIG. 9 Optical Characteristic Measurement Equipment and Method

Ta= $25\pm2^{\circ}$ C, VDD,H_VDD,VGH,VGL=typ, fv=120Hz, Clk=297MHz, I_{c} = 165mA (Tvp)

Table 8. OPTICAL CHARACTERISTICS

14510 01 01	1107	CHARACIL	11101100		IV= I	20HZ, CIK=2	9/MHz, I _F = 165	oma (Typ)	
			Symph al		Value		Unit	Nets	
Parameter			Symbol	Min	Тур	Max	Unit	Note	
Contrast Ratio		CR	1000	1400	-		1		
Surface Lumi	nance,	white	L _{WH}	360	450	-	cd/m ²	2	
Luminance Va	ariation		δ _{WHITE} 5P	-	-	1.3		3	
Deenenee Tin		Rising	Tr	-	8	12		4	
Response Tin	ne	Falling	Tf	-	10	14	ms	4	
		 	Rx		0.649				
		RED	Ry	1	0.332				
		GREEN	Gx		0.307	Typ +0.03			
Color Coordin	nates	GREEN	Gy	Тур	0.595				
[CIE1931]		BLUE	Bx	-0.03	0.149				
		BLUE	Ву		0.059				
		WHITE	Wx	ļ	0.279				
		*******	Wy		0.292				
Color Tempera	ature				10,000		K		
Color Gamut					72		%		
Viewing Angle	e (CR>1	10)							
	x axis, ı	right(φ=0°)	θr	89	-	-			
		eft (φ=180°)	θΙ	89	-	-	dograa	5	
	y axis, ι	up (φ=90°)	θu	89	-	degree -			
	y axis, o	down (φ=270°)	θd	89	-	-			
Gray Scale				-	-	_		6	

Product Specification

Note : 1. Contrast Ratio(CR) is defined mathematically as :

Surface Luminance at all white pixels

Surface Luminance at all black pixels

It is measured at center 1-point.

- 2. Surface luminance is determined after the unit has been 'ON' and 1Hour after lighting the backlight in a dark environment at 25±2°C. Surface luminance is the luminance value at center 1-point across the LCD surface 50cm from the surface with all pixels displaying white. For more information see the FIG. 10.
- 3. The variation in surface luminance , δ WHITE is defined as : $\delta \, \text{WHITE}(5\text{P}) = \text{Maximum}(L_{\text{on1}}, L_{\text{on2}}, \, L_{\text{on3}}, \, L_{\text{on4}}, \, L_{\text{on5}}) \, / \, \text{Minimum}(L_{\text{on1}}, L_{\text{on2}}, \, L_{\text{on3}}, \, L_{\text{on4}}, \, L_{\text{on5}}) \, / \, \text{Where } L_{\text{on1}} \, \text{to } L_{\text{on5}} \, \text{are the luminance with all pixels displaying white at 5 locations} \, .$ For more information, see the FIG. 10.
- 4. Response time is the time required for the display to transit from G(255) to G(0) (Rise Time, Tr_R) and from G(0) to G(255) (Decay Time, Tr_D).
- 5. Viewing angle is the angle at which the contrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD module surface. For more information, see the FIG. 12.
- Gray scale specificationGamma Value is approximately 2.2. For more information, see the Table 9.

Table 9. GRAY SCALE SPECIFICATION

Gray Level	Luminance [%] (Typ)
L0	0.07
L15	0.27
L31	1.04
L47	2.49
L63	4.68
L79	7.66
L95	11.5
L111	16.1
L127	21.6
L143	28.1
L159	35.4
L175	43.7
L191	53.0
L207	63.2
L223	74.5
L239	86.7
L255	100

	Gray Level	Gamma Ref.
	L0	Gamma9
	L1	Gamma8
	L31	Gamma7
Positive	L63	Gamma6
Voltage	L127	Gamma5
	L191	Gamma4
	L223	Gamma3
	L255	Gamma1
	L255	Gamma18
	L223	Gamma16
	L191	Gamma15
Negative	L127	Gamma14
Voltage	L63	Gamma13
	L31	Gamma12
	L1	Gamma11
	L0	Gamma10

Ver. 1.2 18 /34

Global LCD Panel Exchange Center



LC470EUH

Product Specification

Measuring point for surface luminance & luminance variation

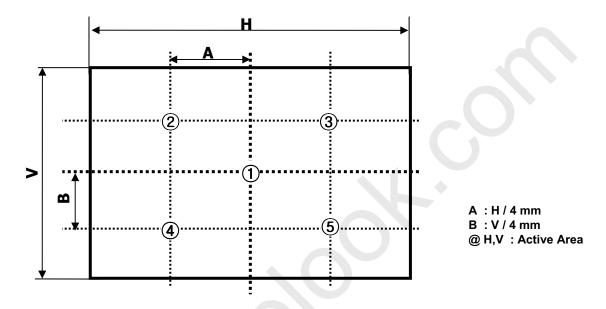


FIG. 10 5 Points for Luminance Measure

Response time is defined as the following figure and shall be measured by switching the input signal for "Gray(N)" and "Gray(M)".

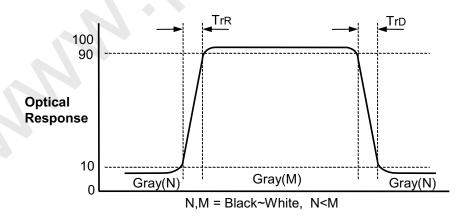


FIG. 11 Response Time



Product Specification

Dimension of viewing angle range

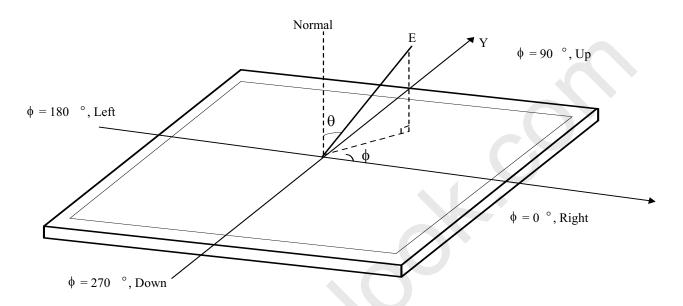


FIG.12 Viewing Angle



Product Specification

5. Mechanical Characteristics

Table 10 provides general mechanical characteristics.

Table 10. MECHANICAL CHARACTERISTICS

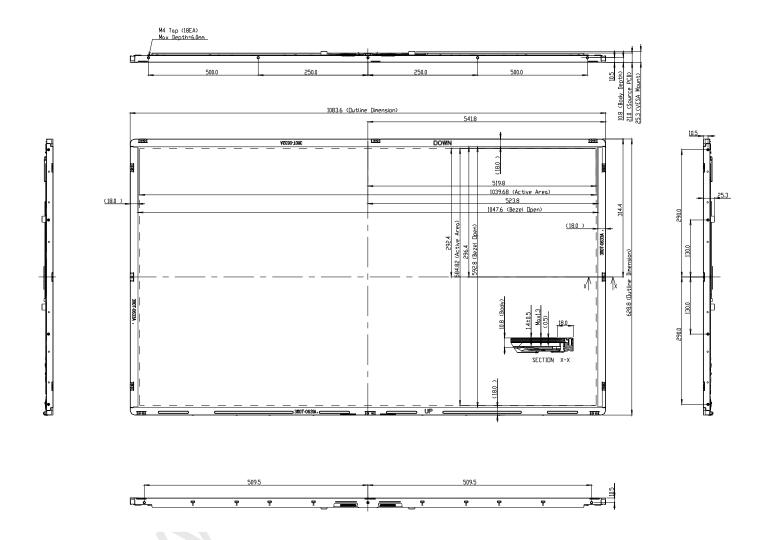
Item	Value				
	Horizontal	1083.6 mm			
Outline Dimension	Vertical	628.8 mm			
	Depth	10.8mm(Body)/21.0mm(Depth)			
Bezel Area	Horizontal	1047.6 mm			
Dezei Area	Vertical	592.8 mm			
Activo Dicplay Area	Horizontal	1039.68 mm			
Active Display Area	Vertical	584.82 mm			
Weight	14.0 Kg (Typ.), 15.5kg (Max.)				

Note: Please refer to a mechanical drawing in terms of tolerance at the next page.



Product Specification

[FRONT VIEW]





Wispecified tolerances are to be ±1.0mm.

Tift and portial disposition tolerance of display area are as follohing.
(1) X-Direction: IA-BI 1.5gm
(2) Y-Direction: IC-DI 1.5gm

_Bezel open

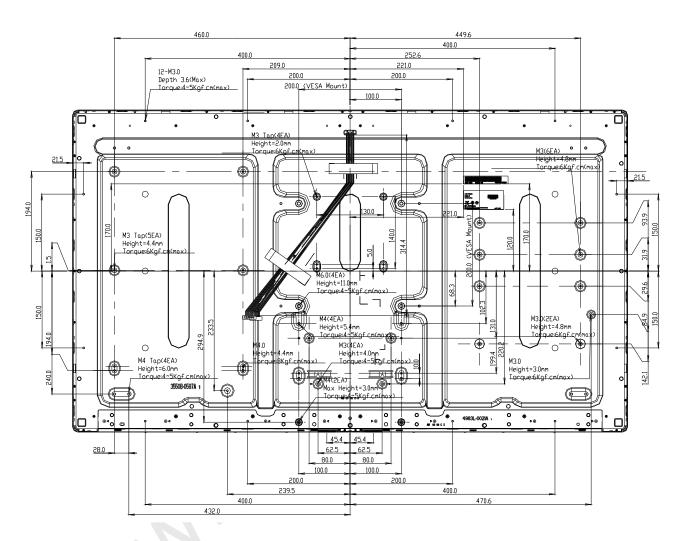
3. Torque: 35 ~ 5.0Kgfcn 4. This part should be contains Eco-hazardous substances (Pb. Cd. Hg. Cr6+, PBB, PBBE, etc.) within standard level of LG Display, Details should be followed Green Procurement standard(B-8022). Especially, Part should be followed and controlled the following specifications.

(i) Eco-hazardous substances test report should be submitted
when Part certification test and First Mass Production.
(2) Bont' flow Eco-hazardous substances into resin by using scrap.
(3) Don't flow Eco-hazardous substances into resin by using inpurities or improper stuff.



Product Specification

[REAR VIEW]



Ver. 1.2 23 /34



Product Specification

6. Reliability

Table 11. ENVIRONMENT TEST CONDITION

No.	Test Item	Condition
1	High temperature storage test	Ta= 60°C 240h
2	Low temperature storage test	Ta= -20°C 240h
3	High temperature operation test	Ta= 50°C 50%RH 240h
4	Low temperature operation test	Ta= 0°C 240h
5	Vibration test (non-operating)	Wave form : random Vibration level : 1.0Grms Bandwidth : 10-300Hz Duration : X,Y,Z, 30 min Each direction per 10 min
6	Shock test (non-operating)	Shock level : 50Grms Waveform : half sine wave, 11ms Direction : \pm X, \pm Y, \pm Z One time each direction
7	Humidity condition Operation	Ta= 40 °C ,90%RH
8	Altitude operating storage / shipment	0 - 15,000 ft 0 - 40,000 ft

Note: Before and after Reliability test, LCM should be operated with normal function.

Ver. 1.2 24 /34



Product Specification

7. International Standards

7-1. Safety

- a) UL 60065, Seventh Edition, Underwriters Laboratories Inc.
 Audio, Video and Similar Electronic Apparatus Safety Requirements.
- b) CAN/CSA C22.2 No.60065:03, Canadian Standards Association. Audio, Video and Similar Electronic Apparatus Safety Requirements.
- c) EN 60065:2002 + A11:2008, European Committee for Electrotechnical Standardization (CENELEC). Audio, Video and Similar Electronic Apparatus Safety Requirements.
- d) IEC 60065:2005 + A1:2005, The International Electrotechnical Commission (IEC).
 Audio, Video and Similar Electronic Apparatus Safety Requirements.
 (Including report of IEC60825-1:2001 clause 8 and clause 9)

Notes

1. Laser (LED Backlight) Information

Class 1M LED Product IEC60825-1: 2001 Embedded LED Power (Class1M) Power: 6.5896 mW (Max.) Wavelength: 277 ~526 (nm) Width: 1.6 x 0.6 (mm)

2. Caution

: LED inside.

Class 1M laser (LEDs) radiation when open.

Do not open while operating.

7-2. Environment

a) RoHS, Directive 2002/95/EC of the European Parliament and of the council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment

Ver. 1.2 25 /34



Product Specification

8. Packing

8-1. Information of LCM Label

a) Lot Mark

Α	В	С	D	Е	F	G	Н	I	J	К	L	М
---	---	---	---	---	---	---	---	---	---	---	---	---

A,B,C : SIZE(INCH)

E: MONTH

D : YEAR

F~ M: SERIAL NO.

Note

1. YEAR

Year	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010
Mark	1	2	3	4	5	6	7	8	9	0

2. MONTH

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Mark	1	2	4	4	5	6	7	8	9	Α	В	С

b) Location of Lot Mark

Serial NO. is printed on the label. The label is attached to the backside of the LCD module. This is subject to change without prior notice.

8-2. Packing Form

a) Package quantity in one Pallet: 13 pcs

b) Pallet Size: 1300 mm X 1140 mm X 850 mm

Ver. 1.2 26 /34



Product Specification

9. Precautions

Please pay attention to the followings when you use this TFT LCD module.

9-1. Mounting Precautions

- (1) You must mount a module using specified mounting holes (Details refer to the drawings).
- (2) You should consider the mounting structure so that uneven force (ex. Twisted stress) is not applied to the module. And the case on which a module is mounted should have sufficient strength so that external force is not transmitted directly to the module.
- (3) Please attach the surface transparent protective plate to the surface in order to protect the polarizer. Transparent protective plate should have sufficient strength in order to the resist external force.
- (4) You should adopt radiation structure to satisfy the temperature specification.
- (5) Acetic acid type and chlorine type materials for the cover case are not desirable because the former generates corrosive gas of attacking the polarizer at high temperature and the latter causes circuit break by electro-chemical reaction.
- (6) Do not touch, push or rub the exposed polarizers with glass, tweezers or anything harder than HB pencil lead. And please do not rub with dust clothes with chemical treatment.
 Do not touch the surface of polarizer for bare hand or greasy cloth.(Some cosmetics are detrimental to the polarizer.)
- (7) When the surface becomes dusty, please wipe gently with absorbent cotton or other soft materials like chamois soaks with petroleum benzine. Normal-hexane is recommended for cleaning the adhesives used to attach front / rear polarizers. Do not use acetone, toluene and alcohol because they cause chemical damage to the polarizer.
- (8) Wipe off saliva or water drops as soon as possible. Their long time contact with polarizer causes deformations and color fading.
- (9) Do not open the case because inside circuits do not have sufficient strength.

9-2. Operating Precautions

- (1) The spike noise causes the mis-operation of circuits. It should be lower than following voltage : $V=\pm 200 \text{mV}$ (Over and under shoot voltage)
- (2) Response time depends on the temperature.(In lower temperature, it becomes longer.)
- (3) Brightness depends on the temperature. (In lower temperature, it becomes lower.) And in lower temperature, response time(required time that brightness is stable after turned on) becomes longer
- (4) Be careful for condensation at sudden temperature change. Condensation makes damage to polarizer or electrical contacted parts. And after fading condensation, smear or spot will occur.
- (5) When fixed patterns are displayed for a long time, remnant image is likely to occur.
- (6) Module has high frequency circuits. Sufficient suppression to the electromagnetic interference shall be done by system manufacturers. Grounding and shielding methods may be important to minimized the interference.
- (7) Please do not give any mechanical and/or acoustical impact to LCM. Otherwise, LCM can't be operated its full characteristics perfectly.
- (8) A screw which is fastened up the steels should be a machine screw. (if not, it can causes conductive particles and deal LCM a fatal blow)
- (9) Please do not set LCD on its edge.
- (10) The conductive material and signal cables are kept away from LED driver inductor to prevent abnormal display, sound noise and temperature rising.

Ver. 1.2 27 /34



Product Specification

9-3. Electrostatic Discharge Control

Since a module is composed of electronic circuits, it is not strong to electrostatic discharge. Make certain that treatment persons are connected to ground through wrist band etc. And don't touch interface pin directly.

9-4. Precautions for Strong Light Exposure

Strong light exposure causes degradation of polarizer and color filter.

9-5. Storage

When storing modules as spares for a long time, the following precautions are necessary.

- (1) Store them in a dark place. Do not expose the module to sunlight or fluorescent light. Keep the temperature between 5°C and 35°C at normal humidity.
- (2) The polarizer surface should not come in contact with any other object. It is recommended that they be stored in the container in which they were shipped.

9-6. Handling Precautions for Protection Film

- (1) The protection film is attached to the bezel with a small masking tape. When the protection film is peeled off, static electricity is generated between the film and polarizer. This should be peeled off slowly and carefully by people who are electrically grounded and with well ion-blown equipment or in such a condition, etc.
- (2) When the module with protection film attached is stored for a long time, sometimes there remains a very small amount of glue still on the bezel after the protection film is peeled off.
- (3) You can remove the glue easily. When the glue remains on the bezel surface or its vestige is recognized, please wipe them off with absorbent cotton waste or other soft material like chamois soaked with normalhexane.

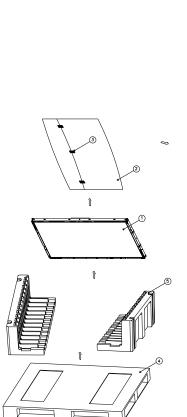
Ver. 1.2 28 /34

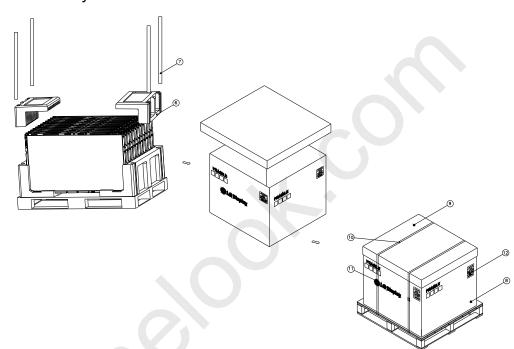


Product Specification

APPENDIX-I

■ LC470EUH-SCA1 – Pallet Ass'y



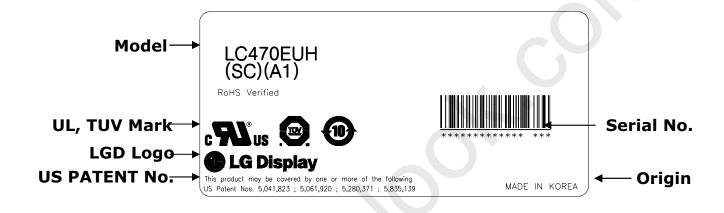


NO.	DESCRIPTION	MATERIAL
1	LCD Module	
2	BAG	47INCH
3	TAPE	MASKING 20MMX50M
4	PALLET	PAPER 1300X1140X126MM
5	PACKING,BOTTOM	EPS
6	PACKING,TOP	EPS
7	ANGLE,POST	PAPER
8	ANGLE,PACKING	PAPER
9	BAND,CLIP	STEEL
10	BAND	PP
11	TAPE	OPP
12	LABEL	YUPO 80G 100X70



APPENDIX- II-1

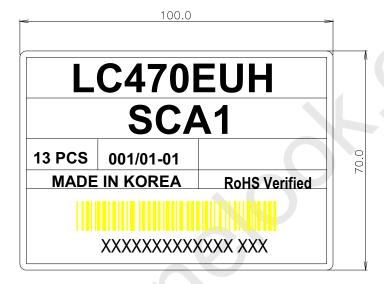
■ LC470EUH-SCA1-LCM Label





APPENDIX- II-2

■ LC470EUH-SCA1-Pallet Label



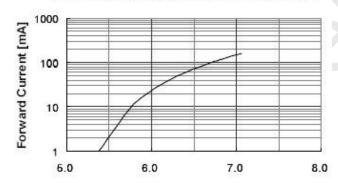
APPENDIX-III

Global LCD Panel Exchange Center

■ LED Array Electrical Spec.

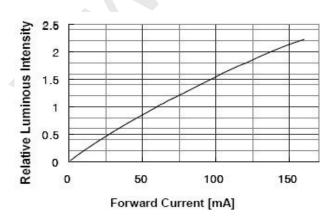
Items	Symbol	Condition	Min	Тур	Max	Unit
U 12 YH 1700	V _F	I _{FM} =165mA	127.6	136.4	145.2	٧
Array Operating Voltage	△Vop *2)	I _{FM} =165mA	9	-	1.7	٧
Luminous of White	lv	I _{FM} =165mA	11,400	12,000	-	nit
	C _X	I _{FM} =165mA	0.250	0.258	0.266	
Color Chromaticity	C _Y	I _{FM} =165mA	0.200	0.208	0.216	
Bright Uniformity *3)	Bu	I _{FM} =165mA	90	2	-	%
Color Uniformity *4)	∆u'v'	I _{FM} =165mA	*	· ·	0.007	

■ Forward Current vs. Forward Voltage.



Forward Voltage [V]

Forward current vs. Relative luminance intensity.





APPENDIX- IV

■ Local Dimming Block Pin Matching

[CN2]

	-
Pin No	Block
1	Vo_2
2	N.C
3	A6
4	A5
5	A4
6	N.C
7	N.C
8	N.C
9	A3
10	A2
11	A 1
12	N.C
13	Vo_2

#4-1	#4-2	#4-3	#3-3	#3-2	#3-1
		T-c	on	Fr	ont
A1	A2	A3	A4	A5	A6
B1	B2	В3	B4	B5	В6
#1-1	#1-2	#1-3	#2-3	#2-2	#2-1

#2-1	#2-2	#2-3	#1-3	#1-2	#1-1
				Fr	ont
В6	B5	B4	В3	B2	B1
A6	A5	A4 T- C	A3	A2	A1
#3-1	#3-2	#3-3	#4-3	#4-2	#4-1

[CN1]

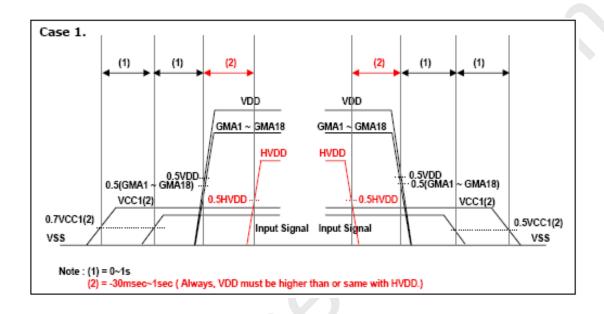
_	
Pin No	Block
1	Vo_1
2	N.C
3	B1
4	B2
5	В3
6	N.C
7	N.C
8	B4
9	B5
10	В6
11	N.C
12	Vo_1

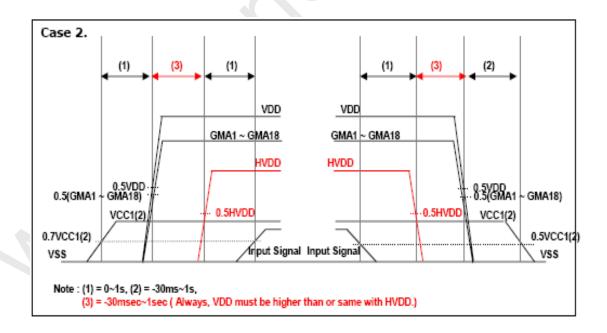
Ver. 1.2 33 /34



APPENDIX- V

■ LC470EUH-SCA1-Source D-IC Power Sequence





- Input Signal : SOE,POL,GSP,H CONV,OPT N

Ver. 1.2 34 /34